



M0120SD-201MDB1-1

Vacuum Fluorescent Display Module

RoHS Compliant

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NAME



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1. SCOPE

This specification applies to VFD module

2. FEATURES

- 2.1 Since a DC/DC converter is used, only+5Vdc power source is required to operate the module.
- 2.2 High quality display and luminance.
- 2.3 ASCII and Japanese characters (CG-ROM font).

3. GENERAL DESCRIPTIONS

- 3.1 This specification becomes effective after being approved by the purchaser.
- 3.2 When any conflict is found in the specification, appropriate action shall be taken upon agreement of both parties.
- 3.3 The expected necessary service parts should be arranged by the customer before the completion of production.

4. PRODUCT SPECIFICATIONS

4.1 Type

Table 1

Туре	
Digit Format	5*7 Dot Matrix

4.2 Outer Dimensions, Weight (See Fig 7 on page 5/11 for details)

Table_2

Parameter		Specification	Unit
Outer Width		150.0 \pm 1.0	mm
Dimensions	Height	32.0 ± 1.0	mm
	Thickness	25.5 Max	mm
Weight		Typical 60	g



4.3 Specifications of the Display Panel

Table_3

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Parameter		Specification	Unit
Display Size (W*H)		92. 7*4. 9	mm
Number of Digit		20 Digits*1 Line	_
Character Size (W*H)		3. 4*4. 9	mm
Character Pitch		4. 7	mm
Dot Size		0. 4*0. 4	mm
Display Color		Blue-Green (505 nm)	-

4.4 Environment Conditions

 $Table_4$

Parameter	Symbol	Min.	Max.	Unit
Operating Temperature	Topr	-40	+85	$^{\circ}$
Storage Temperature	Tstg	-50	+95	$^{\circ}$
Humidity (Operating)	Hopr	0	85	%
Humidity(Non-operating)	Hstg	0	90	%
Vibration (10 \sim 55 Hz)			4	G
Shock			40	G

4.5 Absolute Maximum Ratings

 $Table_5$

Parameter	Symbol	Min.	Max.	Unit
Supply Voltage	Vcc	-0.3	5. 5	Vdc
Input Signal Voltage	Vis	-0.3	5. 5	Vdc

4.6 Recommend Operating Conditions

Table_6

Parameter	Symbol	Min.	Тур.	Max.	Unit
Supply Voltage	Vcc	4. 5	5. 0	5. 5	Vdc
Signal(Logic)Input Voltage	Vis	0	_	Vcc	Vdc
Operating Temperature	Topr	-20	+25	+70	$^{\circ}$

4.7 DC Characteristics (Ta=+25℃, Vcc=+5.0Vdc)

Table_7

Parameter		Symbol	Min.	Тур.	Max.	Unit
Supply Current **)		Icc	_	200	250	mA
Logic Input	"H" Level	Vih	0.7*Vcc	_	_	Vdc
Voltage	"L" Level	Vil	-	_	0.3*Vcc	Vdc
Luminance		L	100	200	_	Ft-L
						(cd/m^2)

 $[\]divideontimes$) The surge current can be approx. 3 times the specified supply current at power on .

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4.8 Timing Chart and AC Characteristics

4.8.1 Power-on Reset and /or RESET Signal Timing

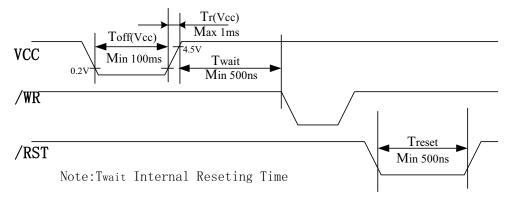


Fig-1 Power-on Reset and RESET signal Timing

4.8.2 i80 type CPU bus write in Timing

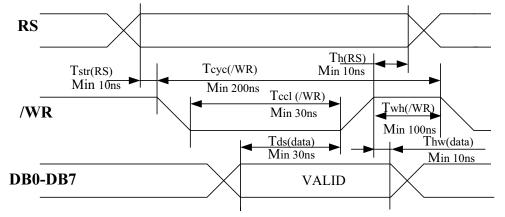


Fig –2 Data write-in Timing Diagram

4.8.3 i80 type CPU bus read-out Timing

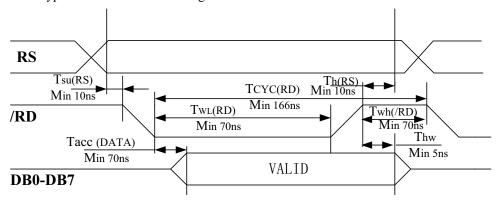


Fig-3 Data Read-out Timing Diagram (i80 bus interface)



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4.8.4 M68 type CPU bus write in timing

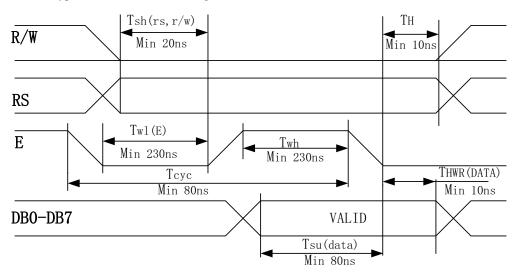


Fig-4 Data write-in Timing Diagram(M68 bus interface)

4.8.5 M68 type CPU bus read-out Timing

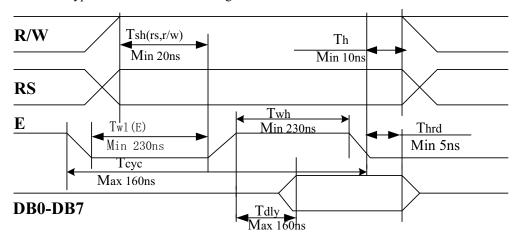


Fig-5 Data read-out Timing Diagram (M68)

4.9 Connector Pin Assignment

Fourteen of through holes are prepared for power supply and signal interface. A connector may be able to soldered to the holes.

The third hole (pin #3) can be used for reset input if the soldering pad "JP1" is short-circuited.

(Refer to "Fig-6 System Block Diagram" on next page.)

No.	Signal	No.	Signal
1	GND	8	DB1
2	Vcc	9	DB2
3	/RST	10	DB3
4	RS	11	DB4
5	R/W(/WR)	12	DB5
6	E(/RD)	13	DB6
7	DB0	14	DB7



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4.10 System Block Diagram

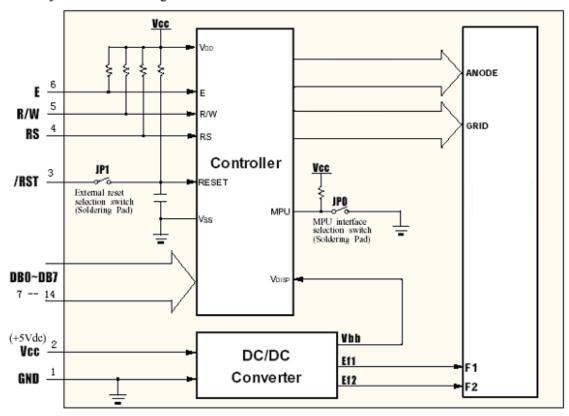


Fig-6 System Block Diagram of this VFD Module

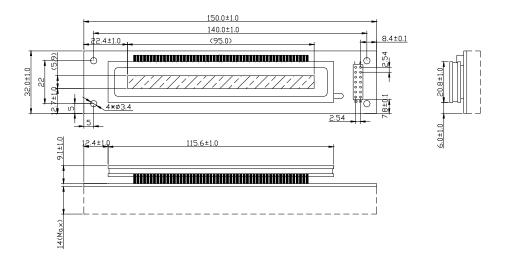


Fig-7 Outer dimensions



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4.11 Pattern Details

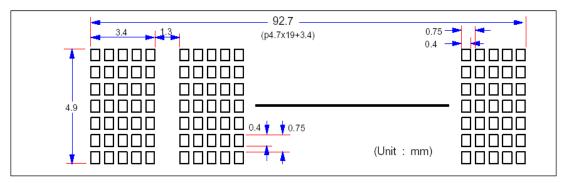


Fig-8. Pattern Details

5. FUNCTION DESCRIPTIONS

5.1 Registers in VFD Controller

The VFD controller has two 8-bit registers, an instruction register (IR) and a data register (DR). IR stores instruction codes, such as display clear and cursor shift, and address information for DD-RAM and CG-RAM. The IR can only be written from the host MPU. DR temporarily stores data to be written into DD-RAM or CG-RAM and temporarily stores data to be read from DD-RAM or CG-RAM. Data written into the DR from the MPU is automatically written into DD-RAM or CG-RAM by an internal operation. The DR is also used for data storage when reading data from DD-RAM or CG-RAM. When address information is written into the IR, data is read and then stored into the DR from DD-RAM or CG-RAM by internal operation. Data transfer between MPU is then completed when the MPU reads the DR. After the read, data in DD-RAM or CG-RAM at the next address is sent to the DR for the next read from the MPU. By the register selector (RS) signal, these two registers can be selected (See Table-8).



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Table-8 Register Selection

RS	M68	i8	0	Operation
KS	R/W	/RD	/WR	Operation
0	0	1 0		IR write as an internal operation (display clear, ect.)
0	1	0 1		Read busy flag (DB7) and address counter (DB0 to DB6)
1	0	1	0	DR write as an internal operation (DR to DD-RAM or CG-RAM)
1	1	0 1		DR read as an internal operation (DD-RAM or CG-RAM to DR)

5.1.1 Busy Flag (BF)

When the busy flag is 1, the controller is in the internal operation mode, and the next instruction will not be accepted. When RS =0 and R/W=1 (Table-8), the busy flag is output to DB7.

The next instruction must be written after ensuring that the busy flag is 0.

5.1.2 Address Counter (ACC)

The address counter (ACC) assigns addresses to both DD-RAM and CG-RAM. When an address of an instruction is written into the IR, the address information is sent from the IR to the ACC. Selection of either DD-RAM or CG-RAM is also determined concurrently by the instruction. After writing into (reading from) DD-RAM or CG-RAM, the ACC is automatically incremented by 1 (decremented by 1). The ACC contents are then output to Db0 to Db6 when RS =0 and R/W=1 (See Table-8).

5.1.3 Display Data RAM (DD-RAM)

Display data RAM (DD-RAM) stores display data represented in 8-bit character codes.

The area in DD-RAM that is not used for display can be used as general data RAM.

See Table-9 for the relationships between DD-RAM addresses and positions on the VFD

Table-9 Relation between Digit Position and DD-RAM data

	Left End	2 nd Column	3 rd column	 15 th Column	Right End
1 st Row	00H	01H	02H	 0EH	13H

5.1.4 Character Generator ROM (CG-ROM)

The character generator ROM (CG-ROM) generates character patterns of 5x7 dots from 8-bit character codes (table-10). It can generate 240 kinds of 5x7 dots character patterns.

The character fonts are shown on the following page. The character codes 00H to13H are allocated to the CG-RAM.

5.1.5 Character Generator RAM (CG-RAM)

In the character generator RAM (CG-RAM), the user can rewrite character patterns by program.

For 5×7 dots and cursor, eight character patterns can be written. Write into DD-RAM the character codes at the addresses shown as the left column of Table-10 to show the character patterns stored in CG-RAM.

See Table-11 for the relationship between CG-RAM addresses and data and display patterns and refer to

Fig-10 for dot assignment of VFD.

Areas that are not used for display can be used as general data RAM

1	2	3	4	5
6	7	8	9	10
11	12	13	14	15
16	17	18	19	20
21	22	23	24	25
26	27	28	29	30
31	32	33	34	35



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Table-10 Characters Font Table (CG-ROM)and CG-RAM codes

	IInn		:+ a	DD7	0								1	1	1	_	1	-1	1	1
	opp	er b	oits	DB7 DB6	$\begin{bmatrix} 0 \\ 0 \end{bmatrix}$	0	$\begin{vmatrix} 0 \\ 1 \end{vmatrix}$	$\begin{vmatrix} 0 \\ 1 \end{vmatrix}$	$\begin{vmatrix} 0 \\ 1 \end{vmatrix}$	$\begin{vmatrix} 1 \\ 0 \end{vmatrix}$	$\begin{bmatrix} 1 \\ 0 \end{bmatrix}$	$\begin{vmatrix} 1 \\ 0 \end{vmatrix}$	$\begin{vmatrix} 1 \\ 0 \end{vmatrix}$	1 1	1 1	$\begin{vmatrix} 1 \\ 1 \end{vmatrix}$	1 1			
				DB6 DB5	0	0	1	1	0	$\begin{bmatrix} 1 \\ 0 \end{bmatrix}$	1	1	0	0	$\begin{vmatrix} 0 \\ 1 \end{vmatrix}$	$\begin{vmatrix} 0 \\ 1 \end{vmatrix}$	0	0	1	1
Lowe	er t	oits		DB4	0	1	$\begin{vmatrix} 1 \\ 0 \end{vmatrix}$	1	0	1	0	1	0	1	0	1	0	1	0	1
DB0	DB1	DB2	DB3		0	1	2	3	4	5	6	7	8	9	A	В	C	D	E	F
0	0	0	0	0	CG-RAM (1)	I		0	0	P	١,	P	Ä	Æ		100000	Ŋ	1001 1001	(X	p
0	0	0	1	1	CG-RAM (2)		H H			Q	1001 1000 1000	쐒	Å	**	0	,	7	4	ä	q
0	0	1	0	2	CG-RAM (3)		11	1000 1000		R	b	۳	Å	Ľ	nux E	4	IJ	X,	ß	8
0	0	1	1	3	CG-RAM (4)		#	3	C		C.	,000 ,000 ,000		R		ņ	1001	10000X 10000X	٤	607
0	1	0	0	4	CG-RAM (5)		\$	4	D			t			ኣ	100000	ŀ	17	H	Ω
0	1	0	1	5	CG-RAM (6)		**************************************	1000 1000 1000	9000 9000	U	6	u	9000K	O	*	7	*	100	C	ü
0	1	1	0	6	CG-RAM (7)		& &	6	F	Ų	f	Ų	ŭ	*	1000	Ħ	100x	10000 10000 10000	P	1 0000
0	1	1	1	7	CG-RAM (8)		7	7	G	W	1000	W	ö	ø	"	notice notice	7	,, ,,,	9	M
1	0	0	0	8	CG-RAM (1)	100	Ç	8	H	X	h	X	Ø		4	ŋ	*	IJ	ŗ	X
1	0	0	1	9	CG-RAM (2)	h	7	9	I	Y	1		ф	ŗ	ŋ	T	Į	lþ	* §	닠
1	0	1	0	A	CG-RAM (3)	¥	*	#	J		j	****	Ü	4	1000		'n	V	j	NOTE N
1	0	1	1	В	CG-RAM (4)		-	7	K		k	{	ü	ξ, 10001	#	Ħ	1000		X	F
1	1	0	0	C	CG-RAM (5)	*	7	<	l	¥	1	HOROGODO	١,	>	ħ	:)	,	ŋ	¢	m
1	1	0	1	D	CG-RAM (6)	þ	300001	Mann			M	1	7	4	1000	Z	ኅ		1))))))
1	1	1	0	E	CG-RAM (7)	4	#	>	N	٨	h	→	Ŵ	*	100			4,4		
1	1	1	1	F	CG-RAM (8)	<u>.</u>	/	?		M	O	4	5	.		Ų.	1000g ***		Ö	



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Table-11 Relationship between CG-RAM address, Character Codes (DD-RAM) AND 5*7 Dot Character Patterns (CG-RAM)

1 att	C1115	(0)	<i>J</i> 1\(\frac{1}{2}\)	1111)																		_
		Ch	aract	er Co	odes			(CG-R	AM.	ADD	RES	S			C	haract	er Pat	terns			
		(DD	-RA	M D	ATA)				(CG-RAM data)													
D	D	D	D	D	D	D	D	A	A	A	A	A	A	D	D	D	D	D	D	D	D	
7	6	5	4	3	2	1	0	5	4	3	2	1	0	7	6	5	4	3	2	1	0	
											0	0	0	×	×	×	1	2	3	4	5	
											0	0	1	×	×	×	6	7	8	9	10	C1
											0	1	0	×	×	×	11	12	13	14	15	Character
0	0	0	0	×	0	0	0	0	0	0	0	1	1	×	×	×	16	17	18	19	20	Pattern(0)
											1	0	0	×	×	×	21	22	23	24	25	
											1	0	1	×	×	X	26	27	28	29	30	
											1	1	0	×	×	X	31	32	33	34	35	
											0	0	0	×	×	×	1	2	3	4	5	
											0	0	1	×	×	X	6	7	8	9	10	
											0	1	0	×	×	X	11	12	13	14	15	C1 .
0	0	0	0	×	0	0	1	0	0	1	0	1	1	×	×	×	16	17	18	19	20	Character
											1	0	0	×	×	X	21	22	23	24	25	Pattern (1)
											1	0	1	×	×	×	26	27	28	29	30	
											1	1	0	×	×	×	31	32	33	34	35	
											0	0	0	×	×	X	1	2	3	4	5	
											0	0	1	×	×	×	6	7	8	9	10	
																						Character
0	0	0	0	×	1	1	1	1	1	1												Pattern(7)
																						(,)
1	1		1	I	1	1	1	1	1	1	1	1	ı	1	1	1	1	1	ı	1	1	ĺ

Notes: 1. Character code bits 0 to 2 correspond to CG-RAM address bits 3 to 5 (3 bits 8 types).

- 2. CG-RAM address bits 0 to 2 designate the character the pattern line position. The 8th line is the cursor position and its display is formed by a logical OR with the cursor. Maintain the 8th line If bit 4of the 8th line data is 1.1 bit will light up the cursor regardless of the cursor presence
- 3. Character pattern row positions correspond to CG-RAM data bits 0 to 4 (bit 4 being at the left)
- 4. As show Table-11 CG-RAM character patterns are selected when character code bits 4 to 7 are all 0. However, since character code bit 3 has no effect, the display example above can be selected by either character code 00H or 08H
- $5.\ 1\ for\ CG\text{-ram data corresponds display selection and }0\ to\ non\text{-selection.}"\times"\ \text{Indicates\ non-effect.}$



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5.2 Interfacing to the MPU

This VFD module can interface in either two 4-bit operations or one 8-bit operation, thus allowing interfacing with 4-bit or 8-bit MPUs.

** For 4-bit interface data, only four bus lines (DB4 to DB7) are used for transfer. When to use 4-bit parallel data transfer, DB0 to DB3 keep "H" or "L". The data transfer between the VFD module and the MPU is completed after the 4-bit data has been transferred before the four low order bits (for 8-bit operation. DB0 to DB3).

The busy flag (BF) are performed before transferring the higher 4 bits. BF checks are not required before transferring the lower 4 bits.

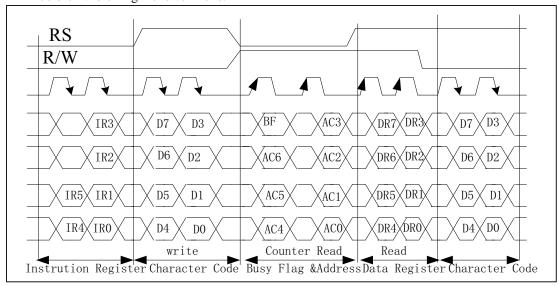


Fig 4-biti transfer Example (M68)

%For 8-bit interface data, all eight bus lines (DB0 to DB7) are used.

5.3 Reset Function

5.3.1 Power-on reset

An internal reset circuit automatically initializes the module when the power is turn on.

The following instructions are executed during the initialization.

1) Display clear

Fill the DD-RAM with 20H (Space Code)

2) Set the address counter to 00H

Set the address counter (ACC) to point DD-RAM.

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3) Display on/off control:

D=0; Display off

B=0; Blinking off

C=0; Cursor off

4) Entry mode set:

L/D=1; Increment by 1

S=0; No shift

5) Function set

IF=1; 8-bit interface data

BR0=BR1=0; Brightness=100%

N=1; 2-line display

6) CPU interface type

When J7=Open; M68 type (Factory Setting)

When J7=Short; i80 type

5.3.2 External reset

In order to use this function, a user must connect the soldering pad "J2". When the soldering pad "J2" is open-circuited, this function is not valid and when it is short-circuited, the third hole (pin #3) is used for external reset input. If low level signal longer than 500ns is input into the hole, reset function being same as power on reset is executed.



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6. INSTRUCTIONS

6.1 Outline

Only the instruction register (IR) and data register (DR) of the VFD controller can be controlled by the user's MPU. Before starting the internal operation of the controller, control information is temporarily stored into these registers to allow interfacing with various MPUs, which operate at different speeds, or various peripheral control devices. The internal operation of the controller is determined by signals sent from the MPU. These signals, which include register selection signal (RS), read/write signal (R/W), and the data bus (DB0 to DB7), make up the controller instructions (See Table-13). There are four categories of instructions that:

- designate controller functions, such as display format, data length, ect.
- Set internal RAM addresses
- Perform data transfer with internal RAM
- Perform miscellaneous functions

Normally instructions that perform data transfer with interval RAM are used the most.

However, auto-increment by 1 (or auto-decrement by 1) of internal RAM addresses after each data write can lighten the program load of the MPU. Since the display shift instruction can perform concurrently with display data write, the user can minimize system development time with maximum programming efficiency.

When an instruction is being executed for internal operation, no instruction other than the busy flag/address read instruction can be executed. Because the busy flag is set to 1 while an instruction is being executed, check it to make sure it is 0 before sending another instruction from the MPU.

Note: Be sure the controller is not in the busy state (BF=0) before sending an instruction from the MPU to the nodule. If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself.

Refer to Table-13 for the list of each instruction execution time.



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Table –13 Instruction Set

Instruction CODE											Description	
mstruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	
Display clear	0	0	0	0	0	0	0	0	0	1	Clear all display an sets DD-ram address 0 in address counter	
Cursor Home	0	0	0	0	0	0	0		1	×	Sets DDRAM address 0 in ACC Also returns the display being shifted to the original position DD RAM content remain unchanged	
Entry Mode set	0	0	0	0	0	0	0	1	I/D	S	Sets the curso direction and specifies display shift. The operations are during WR/RD data	
Display ON/OFF Control	0	0	0	0	0	0	1	D	С	В	Sets all displation on one of the control of the character position (B)	
Cursor or display Shift	0	0	0	0	0	1	S/C	R/L	×	×	Shifts display of cursor, keepin DD-RAM contents.	
Function set	0	0	0	0	1	IF	N	×	BR1	BR0	Sets data length (IF number of displa lines (N), So brightness level (BR1, BR0)	
CGRAM address Setting	0	0	0	1			AC	CG			Sets the CG-RAM address.	
DDRAM Address setting	0	0	1				ADD				Sets the DD-RAM address.	
Busy flag & address setting	0	1	BF		ACC					Read busy flag (BI and address counter (ACC).		



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				T		
Data write to CG	1	0	Data writing	Writes data into CG-RAM or		
or DDRAM	1	U	Data writing	DD-RAM		
Data Read from			D	Read data from CG-RAM or		
CG or DDRAM	1	1	Data reading	DD-RAM		
	I/D=1	: Incr	ement	[Abbreviation]		
	I/D=0	: Dec	rement	DD-RAM: Display Data RAM		
	S=1: 1	Displa	y shift enabled	CG-RAM: Character Generater		
	S=0: 0	Curso	r shift enabled	RAM		
	S/C=1	l: Dis	play shift	ACG: CG-RAM Address		
	S/C=0): Cur	sor move	ADD: DD-RAM Address		
	R/L=1	1: Shi	ft to the right	ACC: Address Counter		
	R/L=0	0: Shi	ft to the left			
	IF=1:	8bits				
*NOTE	IF=0:	4bits				
	N=1:	2 Line	es display			
	N=0:1	l Line	s display			
	BR1,	BR0=	= 00: 100%			
			01: 75%			
			10: 50%			
			11: 25%			
	BF=1					
	BF=0	:Not b				
	.: Do:	n't c	eare			

6.2 Instruction Description

6.2.1 Display Clear

DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	0	1

RS=0, R/W=0

This instructions

- (1) Fills all locations in the display data RAM (DD-RAM) with 20H (Blank-character).
- (2) Clears the contents of the address counter (ACC) to 00H.
- (3) Sets the display for zero character shift (returns original position).
- (4) Sets the address counter(ACC) to point to the DD-RAM.
- (5) If the cursor is displayed, moves the cursor to the left most character in the top line (upper line).
- (6) Sets the address counter (ACC) to increment on the each access of DD-RAM or CG-RAM.



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02H to 03H ×: Don't care

6.2.2 Cursor Home

Ι	OB7	DB6	DB5	DB4	DB3	B DB2	DB1	DB0			
	0	0	0	0	0	0	1	×			
_	RS=0, R/W=0										

This instruction

- (1) Clears the contents of the address counter (ACC) to 00H.
- (2) Sets the address counter (ACC) to point to the DD-RAM.
- (3) Sets the display for zero character shift (returns original position).
- (4) If the cursor is displayed, moves the left most character in the top line (upper line).

6.2.3 Entry Mode Set

DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
0	0	0	0	0	1	I/D	S	
RS	S=0, R	/W=0			,			04H to 07H

The I/D bit selects the way in which the contents of the address counter (ACC) are modified after every access to DD-RAM or CG-RAM.

I/D=1: The address counter (ACC) is incremented.

I/D=0: The address counter (ACC) is decremented.

The S bit enable display shift, instead of cursor shift, after each write or read to the DD-RAM.

S=1: Display shift enabled.

S=0: Cursor shift enabled.

The direction in which the display is shifted is opposite in sense to that of the cursor.

For example, if S=0 and I/D=1, the cursor would shift one character to the right after a MPU writes to DD-RAM. However if S=1 and I/D=1, the display would shift one character to the left and the cursor would maintain its position on panel.

The cursor will already be shifted in the direction selected by I/D during reads of the DD-RAM, irrespective of the value of S. Similarly reading and writing the CG-RAM always shift the cursor.

Also both lines are shifted simultaneously.

Table-14 Cursor move and Display shift by the "Entry Mode Set"

		1 3 3			
I/D	S	After writing DD-RAM data	After reading DD-RAM data		
0	0	The cursor moves one character to the	The cursor moves one character		
		left.	to the left.		
1	0	The cursor moves one character to the	The cursor moves one character to		
1		right.	the right.		
0	1	The display shifts one character to the	The cursor moves one character to		
0	1	right without cursor's move.	the left.		
1	1	The display shifts one character to the left	The cursor moves one character		
	1	without cursor's move.	to the right.		



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6.2.4 Display ON/OFF

Γ	D B7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
	0	0	0	0	1	D	С	В

RS=0, R/W=0

08H to 0FH

X: Don't care

This instruction controls various features of the display.

D=1: Display on , D=0: Display off.
C=1: Cursor on C=0: Cursor off.
B=1: Blinking on B=0: blinking off.

(Blinking is achieved by alternating between a normal and all on display of a character.

The cursor' blink with a frequency of about 1.0 Hz and DUTY 50%)

6.2.5 Cursor/Display Shift

DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	1	S/C	R/L	0	0

RS=0, R/W=0

10H to 1FH

×: Don't care

This instruction shifts the display and/or moves the cursor on character to the left or right, without reading or writing DD-RAM.

The S/C bit selects movement of the cursor or movement of both the cursor and the display.

S/C=1: Shift both cursor and display

S/C=0: Shift cursor only

The R/L bit selects left ward or right ward movement of the display and/or cursor.

R/L=1: Shift one character right

R/L=0: Shift one character left

Table-15 Cursor/Display shift

S/C	R/L	Cursor shift	Display shift
0	0	Move one character to the left	No shift
0	1	Move one character to the right	No shift
1	0	Shift one character to the left with display	Shift one character to the left
1	1	Shift one character to the right with display	Shift one character to the right



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6.2.6.Function Set

DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	IF	N	×	BR1	BR2
RS	S=0, R	/W=0					

20H to 3FH

X: Don't care

This instruction sets width of data bus line.(when to use parallel interface. IM=1). The number of display line and brightness control.

This instruction initializes the system, and must be the first instruction executed after power-on.

The IF bit selects between an 8-bit or 4-bit bus width interface.

IF=1: 8-bit CPU interface using DB7 to DB0

IF=0: 4-bit CPU interface using DB7 to DB4

The N bit selects between 1-line or 2-line display.

N=1: Select 2 line display (Using anode output A1 to A80)

N=0: Select 1 line display (Using anode output A1 to A40. A41 to A80 fixed Low level.)

BR1, BR0 flag is control to brightness of VFD to modulate pulse width of Anode output as follows.

BR1	BR0	Brightness
0	0	100%
0	1	75%
1	0	50%
1	1	25%

6.2.7 Set CG-RAM Address

DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	1			ACC	Ĵ		
RS	S=0, R	/W=0					

40H to 7FH

X: Don't care

This instruction

- (1) Load a new 60bit address into the address counter (ACC).
- (2) Sets the address counter (ACC) to address CG-RAM.

Once "Set CG-RAM Address" has been executed, the contents of the address counter (ACC) will be automatically modified after every access of CG-RAM, as determined by the "Entry Mode Set" instruction.

The active width of the address counter (ACC), when it is addressing CG-RAM, is 6-bit, so the counter will wrap around to 00H from 3FH if more than 64 bytes of data are written to CG-RAM

6.2.8 Set DD-RAM Address

DB7	DB6 DB5	DB4	DB3	DB2	DB1	DB0
1			ADD)		
RS	S=0, R/W=0					

80H to A7H (1-Line) C0H to E7h (2-line)

X: Don't care



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This instruction

- (1) Loads a new 7-bit address into the address counter (ACC).
- (2) Sets the address counter (ACC) to point to the DD-RAM.

Once the "Set DD-RAM Address" instruction has been executed, the contents of the address counter (ACC) will be automatically modified after each access of DD-RAM, as selected by the "Entry Mode Set" instruction.

Table-16 Valid DD-RAM address Ranges

	Number of Character	Address Range
1 st line	10	00H to 13H

6.2.9 Read Busy Flag and Address

DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0

BF	ACC	
----	-----	--

RS=0, R/W=1

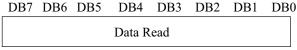
Read busy flag and address reads the flag (BF) indicating that the system is now internally operating on a previously received instruction. If BF is 1, the internal operation is in progress.

BF=1: busy state

BF=0: ready for next instruction, command receivable.

The next instruction will not be accepted until BF is reset to 0.Check the BF status before the next write operation. At the same time, the value of the address counter (ACC) in binary AAAAAA is read out. This address counter (ACC) is used by both CG-RAM and DD-RAM address and its value is determined by the previous instruction. The address counter are the same as for instructions set CG-RAM address and set DD-RAM address.

6.2.10 Write Data to CG or DD-RAM



RS=1, R/W=0

This instruction writes 8-bit binary data (DB7 to DB0) from CG-RAM or DD-RAM.

The previous designation determines whether CG-RAM or DD-RAM is to be read.

Before entering this read instruction, either CG-RAM or DD-RAM address set instruction must be executed. If not executed, the first read data will be invalid. When serially executing read instructions, the next address data is normally read from the second read. The address set instructions need not be executed just before this read instruction when shifting the cursor shift instruction (when reading out DD-RAM).

The operation of the cursor shift instruction is the same as the set DD-RAM address instruction.

After a read, the entry mode automatically increases or decreases the address by 1.



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Note: The address counter (ACC) is automatically incremented or decremented by 1 after the write instructions to CG-RAM or DD-RAM are executed. The RAM data selected by the ACC cannot be read out at this time even if read instructions are executed. Therefore, to correctly read data, execute either the address set instruction or cursor shift instruction (only with DD-RAM), then just before reading the desired data, execute the read instruction from the second time the read instruction is sent.

7. 0 OPERATING RECOMMENDATIONS

- 7.1 Avoid applying excessive shock or vibration beyond the specification for the VFD module.
- 7.2 Since VFDs are made of glass material, careful handling is required.i.e. Direct impact with hard material to the glass surface (especially exhaust tip) may crack the glass.
- 7.3 When mounting the VFD module to your system, leave a slight gap between the VFD glass and your front panel. The module should be mounted without stress to avoid flexing of the PCB.
- 7.4 Avoid plugging or unplugging the interface connection with the power on, otherwise it may cause the severe damage to input circuitry.
- 7.5 Slow starting power supply may cause non-operation because one chip Mico won't be reset.
- 7.6 Exceeding any of maximum ratings may cause the permanent damage.
- 7.7 Since the VFD modules contain high voltage source, careful handing is required during powered on.
- 7.8 When the power is turned off, the capacitor dose not discharge immediately.
 - The high voltage applied to the VFD must not contact to the ICs. And the short-circuit
 - of mounted components on PCB within 30 times the specified current consumption when the power is turned on.
- 7.9 The power supply must be capable of providing at least 3 times the rated current, because the surge current can be more than 3 times the specified current consumption when the power is turned on.
- 7.10 Avoid using the module where excessive noise interference is expected. Noise may affects the Interface signal and causes improper operation. And it is important to keep the length of the interface cable less than 50cm.
- 7.11 Since all VFD modules contain C-MOS ICs, anti-static handing procedures are always required.

NOTE: Newhaven Display reserves the right to change or modify this spec and or design without notice in order to improve the design or ensure the quality of this product.